

# Product Change Notification

The information below reflects a change that is being implemented.

Notice Date: 02/09/2001

Product Category: Core 12; Core 14; SDP

Notification Subject: Change #295 - NSEB is changing 8-Lead SOIC (/SN) (0.150") package leadframe strip

Notification Body:  
CHANGE IMPLEMENTATION NOTICE  
CCB #: 295

Microchip Part # (Old):  
See "Description of Change"

Projected Shipment Date of Revised Device:  
February 28, 2001

Description of Change:  
Microchip's sub-contract assembly of NSEB is changing 8-Lead SOIC (/SN) (0.150") package leadframe strip on the following devices:  
HCS410, PIC12CE518, PIC12CE519, HCS500, PIC12C508, PIC12C509, PIC12C508A, PIC12CR509A, PIC12C509A, HCS101, HCS200, HCS201, HCS300, HCS301, HCS320, HCS360, HCS361, HCS412

Impacts to Data Sheet:  
Device specifications do not change

Reason for Change:  
Improve quality and delivery through standardization

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking)  
No change to device marking

Summary of Qualification Results: (Reference Report Number if applicable):  
Qualification report: Document # Q00018